

MRF24J40MA Data Sheet

2.4 GHz IEEE Std. 802.15.4TM RF Transceiver Module

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the
 intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not
 mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION. QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, Accuron, dsPIC, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PRO MATE, rfPIC and SmartShunt are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL, SmartSensor and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, In-Circuit Serial Programming, ICSP, ICEPIC, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, PICkit, PICDEM, PICDEM.net, PICtail, PIC³² logo, PowerCal, PowerInfo, PowerMate, PowerTool, REAL ICE, rfLAB, Select Mode, Total Endurance, UNI/O, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries

 $\ensuremath{\mathsf{SQTP}}$ is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2008, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

QUALITY MANAGEMENT SYSTEM

CERTIFIED BY DNV

ISO/TS 16949:2002

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEŁLOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



2.4 GHz IEEE Std. 802.15.4TM RF Transceiver Module

Features:

- IEEE Std. 802.15.4™ Compliant RF Transceiver
- Supports ZigBee[®], MiWi™, MiWi™ P2P and Proprietary Wireless Networking Protocols
- Small Size: 0.7" x 1.1" (17.8 mm x 27.9 mm), Surface Mountable
- Integrated Crystal, Internal Voltage Regulator, Matching Circuitry and PCB Antenna
- Easy Integration into Final Product Minimize Product Development, Quicker Time to Market
- Radio Regulation Certification for United States (FCC), Canada (IC) and Europe (ETSI)
- Compatible with Microchip Microcontroller Families (PIC16F, PIC18F, PIC24F/H, dsPIC33 and PIC32)
- Up to 400m Range (outdoor, line-of-sight)

Operational:

- 20/10/5/2.5 MHz Clock Output:
 - Available to drive microcontroller clock
- Operating Voltage: 2.4-3.6V (3.3V typical)
- Temperature Range: -40°C to +85°C Industrial
- Simple, Four-Wire SPI Interface
- · Low-Current Consumption:
 - RX mode: 19 mA (typical)
 - TX mode: 23 mA (typical)
 - Sleep: 2 μA (typical)

· Supports Power Save mode

RF/Analog Features:

- ISM Band 2.405-2.48 GHz Operation
- · Data Rate: 250 kbps
- -94 dBm Typical Sensitivity
- +0 dBm Typical Output Power and 40 dB TX Power Control Range
- Integrated, Low Phase Noise VCO, Frequency Synthesizer and PLL Loop Filter
- Digital VCO and Filter Calibration
- · Integrated RSSI ADC and I/Q DACs
- Integrated LDO
- · High Receiver and RSSI Dynamic Range

MAC/Baseband Features:

- Hardware CSMA-CA Mechanism, Automatic ACK Response and FCS Check
- · Independent Beacon, Transmit and GTS FIFO
- Hardware Security Engine (AES-128) with CTR, CCM and CBC-MAC modes
- · Supports all CCA modes and RSS/LQI
- Automatic Packet Retransmit Capable
- Supports In-Line or Stand-Alone modes for both Encryption and Decryption

FIGURE 1: PIN DIAGRAM

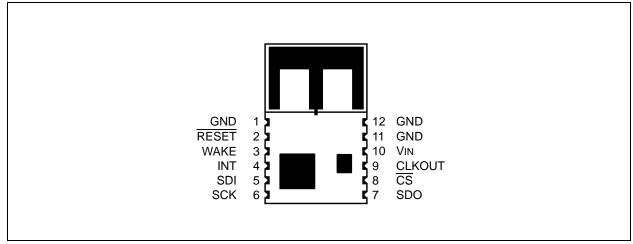


Table of Contents

1.0	Device Overview	5
2.0	Circuit Description	9
3.0	Regulatory Approval	17
4.0	Electrical Characteristics	21
	ndix A: Revision History	
	ficrochip Web Site	
	mer Change Notification Service	
	mer Support	
Read	er Response	26
Produ	ict Identification System	27

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com** or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- · Microchip's Worldwide Web site; http://www.microchip.com
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com to receive the most current information on all of our products.

NOTES:

© 2008 Microchip Technology Inc.

1.0 **DEVICE OVERVIEW**

The MRF24J40MA is a 2.4 GHz IEEE Std. 802.15.4™ compliant, surface mount module with integrated crystal, internal voltage regulator, matching circuitry and PCB antenna. The MRF24J40MA module operates in the non-licensed 2.4 GHz frequency band and is FCC, IC and ETSI compliant. The integrated module design frees the integrator from extensive RF and antenna design, and regulatory compliance testing, allowing quicker time to market.

The MRF24J40MA module is compatible with Microchip's ZigBee[®], MiWi™ and MiWi P2P software stacks. Each software stack is available as a free download, including source code, from the Microchip web site http://www.microchip.com/wireless.

The MRF24J40MA module has received regulatory approvals for modular devices in the United States (FCC), Canada (IC) and Europe (ETSI). Modular approval removes the need for expensive RF and antenna design and allows the end user to place the MRF24J40MA module inside a finished product and not require regulatory testing for an intentional radiator (RF transmitter). See Section 3.0 "Regulatory Approval" for specific requirements to be followed by the integrator.

1.1 **Interface Description**

Figure 1-1 shows a simplified block diagram of the MRF24J40MA module. The module is based on the Microchip Technology MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver chip. The module interfaces to many popular Microchip PIC® microcontrollers via a 4-wire serial SPI interface, interrupt, wake, Reset, power and ground as shown in Figure 1-2. Table 1-1 provides the pin descriptions.

Data communications with the MRF24J40MA module are documented in the "MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver Data Sheet" (DS39776). Refer to the MRF24J40 data sheet for specific serial interface protocol and register definitions.

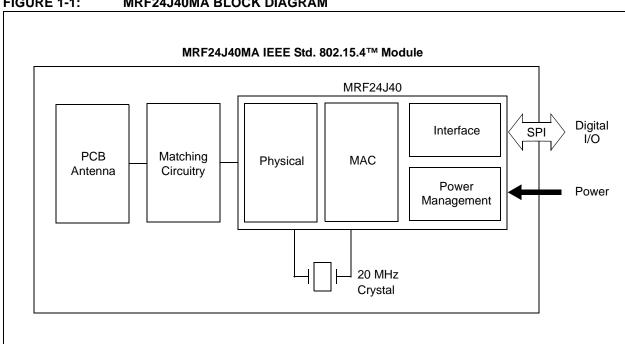


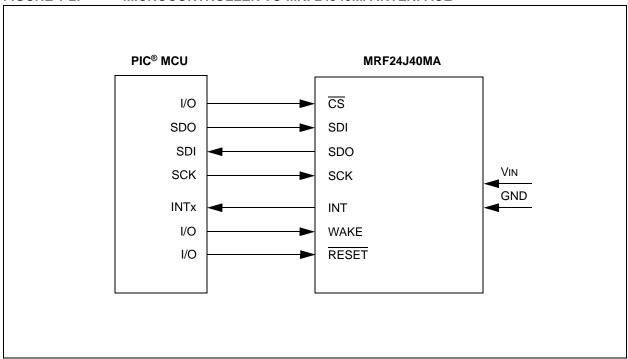
FIGURE 1-1: MRF24J40MA BLOCK DIAGRAM

TABLE 1-1: PIN DESCRIPTION

Pin	Symbol	Туре	Description
1	GND	Power	Ground
2	RESET	DI	Global hardware Reset pin
3	WAKE	DI	External wake-up trigger
4	INT	DO	Interrupt pin to microcontroller
5	SDI	DI	Serial interface data input
6	SCK	DI	Serial interface clock
7	SDO	DO	Serial interface data output from MRF24J40
8	CS	DI	Serial interface enable
9	CLKOUT	DO	20/10/5/2.5 MHz clock output
10	VIN	Power	Power supply
11	GND	Ground	Ground
12	GND	Ground	Ground

Legend: Pin type abbreviation: D = Digital, I = Input, O = Output

FIGURE 1-2: MICROCONTROLLER TO MRF24J40MA INTERFACE



1.2 Mounting Details

The MRF24J40MA is a surface mountable module. Module dimensions are shown in Figure 1-3. The module Printed Circuit Board (PCB) is 0.032" thick with castellated mounting holes on the edge. Figure 1-4 is a recommended host PCB footprint for the MRF24J40MA.

The MRF24J40MA has an integrated PCB antenna. For the best performance, follow the mounting details shown in Figure 1-5. It is recommended that the module be mounted on the edge of the host PCB and an area around the antenna, approximately 1.2", be kept clear of metal objects. A host PCB ground plane around the MRF24J40MA acts as a counterpoise to the PCB antenna. It is recommended to extend the ground plane at least 0.4" around the module.

FIGURE 1-3: MODULE DETAILS

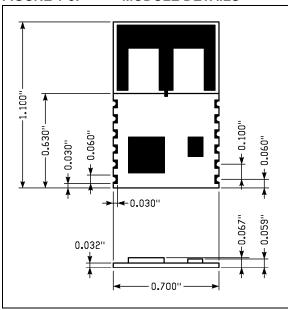


FIGURE 1-4: RECOMMENDED PCB FOOTPRINT

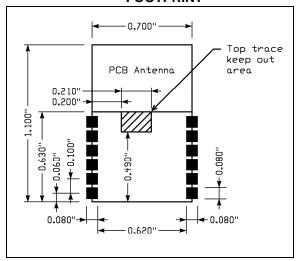
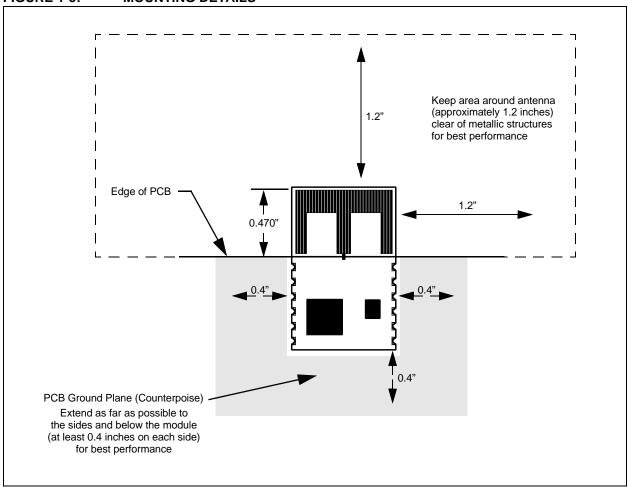


FIGURE 1-5: **MOUNTING DETAILS**



© 2008 Microchip Technology Inc.

2.0 CIRCUIT DESCRIPTION

The MRF24J40MA is a complete 2.4 GHz IEEE Std. 802.15.4™ compliant surface mount module with integrated crystal, internal voltage regulator, matching circuitry and PCB antenna. The MRF24J40MA module interfaces to many popular Microchip PIC microcontrollers via a 4-wire serial SPI interface, interrupt, wake, Reset, power and ground. Data communications with the MRF24J40MA module is documented in the "MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver Data Sheet" (DS39776). Refer to the MRF24J40 data sheet for specific serial interface protocol and register definitions.

2.1 Schematic

A schematic diagram of the module is shown in Figure 2-1 and the Bill of Materials (BOM) is shown in Table 2-1.

The MRF24J40MA module is based on the Microchip Technology MRF24J40 IEEE 802.15.4™ 2.4 GHz RF Transceiver IC. The serial I/O (SCK, SDI, SDO and CS), RESET, WAKE, INT and CLKOUT pins are brought out to the module pins. The SDO signal is tri-state buffered by IC2 to solve a silicon errata where the SDO signal does not release to a high-impedance state after the $\overline{\text{CS}}$ pin returns to its inactive state. Crystal X1 is a 20 MHz crystal with a frequency tolerance of ±20 ppm @ 25°C to meet the IEEE Std. 802.15.4 symbol rate tolerance of ±40 ppm. A balun is formed by components: L1, L3, C2 and C14. L2 is an RF choke and pull-up for the RFP and RFN pins on the MRF24J40. C15 is a DC block capacitor. A low-pass filter is formed by components: L4, C16 and C17. The remaining capacitors provide RF and digital bypass.

FIGURE 2-1: MRF24J40MA SCHEMATIC → 9 CLKOUT 1 GND 11 GND 12 GND 10 VIN OGS 1 SDO IC2 NC7SZ125P5X $\square \square \square$ abla흱 C5 47 pF GND ₹ < C4 47 pF 3 WAKE 2 RESET 25 24 23 NC 22 30 29 NC 28 NC 27 NC 26 20.00 MHz ablaCZ SDI SDO SDO INT MAKE GND GENO3 GE **-**□ VPD OCS2 OSC4 VPD GND VPD VPD VPD CC4 VPD CC4 VPD 10 10 10 11 11 11 11 11 35 55 55 96 32 88 88 68 $\stackrel{\times}{\sim}$ NC Σ₽≷ VDD RFP RFN VDD VDD GND GPIO0 GPIO1 GPIO2 GPIO5 100 PF ₹← %± € \$ L2 3.3 nH £ L1 £ 8.2 nH ₹ ← 1.0 PF <u>₹</u> < C14 0.5 pF C15 0.5 pF NP = Not Placed. Note: PCB Antenna

TABLE 2-1: MRJ24J40MA BILL OF MATERIALS

Designator	Description	Manufacturer	Part Number
C1	Chip Capacitor 0402 X5R 1U	Murata	GRM155R60J105ME19D
C2	Chip Capacitor 0402 COG 1.0P	Johanson Tech.	500R07S1R0BV4T
C3	Chip Capacitor 0402 X7R 10N	Murata	GRM155R71E103KA01D
C4	Chip Capacitor 0402 COG 47P	Murata	GRM1555C1H470JZ01D
C5	Chip Capacitor 0402 COG 47P	Murata	GRM1555C1H470JZ01D
C6	Chip Capacitor 0402 COG 47P	Murata	GRM1555C1H470JZ01D
C7	Chip Capacitor 0402 X7R 10N	Murata	GRM155R71E103KA01D
C8	Chip Capacitor 0402 X5R 1U	Murata	GRM155R60J105ME19D
C9	Chip Capacitor 0402 COG 100P	Murata	GRM1555C1H101JZ01D
C10	Chip Capacitor 0402 COG 47P	Murata	GRM1555C1H470JZ01D
C11	Chip Capacitor 0402 X5R 100N	Murata	GRM155R61A104KA01D
C12	Chip Capacitor 0402 X5R 100N	Murata	GRM155R61A104KA01D
C13	Chip Capacitor 0402 COG 47P	Murata	GRM1555C1H470JZ01D
C14	Chip Capacitor 0402 COG 0.5P	Johanson Tech.	500R07S0R5AV4T
C15	Chip Capacitor 0402 COG 0.5P	Johanson Tech.	500R07S0R5AV4T
C16	Not Used		
C17	Chip Capacitor 0402 COG 2.7P	Murata	GRM1555C1H2R7CZ01D
C18	Chip Capacitor 0402 COG 20P	Murata	GRM1555C1H200JZ01D
C19	Chip Capacitor 0402 COG 20P	Murata	GRM1555C1H200JZ01D
IC1	IEEE 802.15.4™ RF Transceiver	Microchip	MRF24J40-I/ML
IC2	Buffer, SC70 Package	Fairchild	NC7SZ125P5X
L1	Chip Inductor 0402 8.2N	Panasonic	ELJ-RF8N2JFB
L2	Chip Inductor 0402 3.3N	Panasonic	ELJ-RF3N3DFB
L3	Chip Inductor 0402 5.6N	Panasonic	ELJ-RF5N6DFB
L4	Chip Inductor 0402 6.8N	Panasonic	ELJ-RF6N8JFB
R1	Not Used		
X1	20 MHz Crystal	Abracon	ABM8-20.000MHZ-B2-T

2.2 Printed Circuit Board

The MRF24J40MA module printed circuit board is constructed with FR4 material, four layers and 0.032 inches thick. The layers are shown in Figure 2-2 through Figure 2-6. The stack up of the PCB is shown in Figure 2-7.

FIGURE 2-2: TOP SILK SCREEN

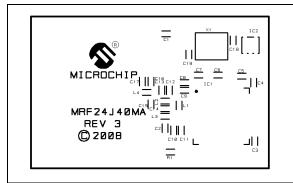


FIGURE 2-3: TOP COPPER

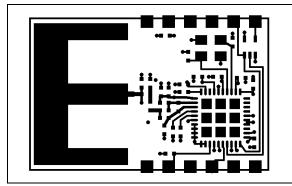


FIGURE 2-4: LAYER 2 – GROUND PLANE

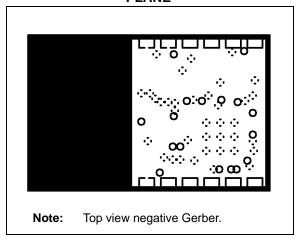


FIGURE 2-5: LAYER 3 – POWER PLANE

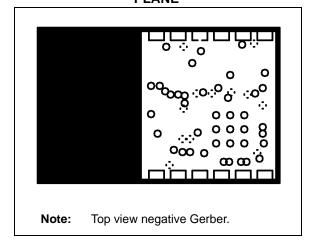
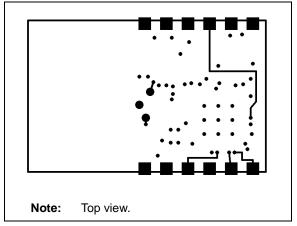
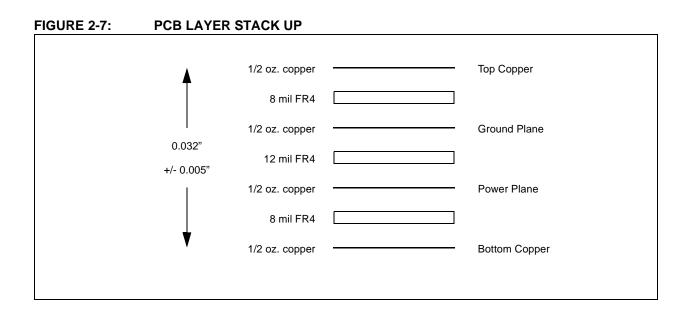


FIGURE 2-6: BOTTOM COPPER





2.3 PCB Antenna

The PCB antenna is fabricated on the top copper trace. Figure 2-8 shows the trace dimensions. The layers below the antenna have no copper traces. The ground and power planes under the components serve as a counterpoise to the PCB antenna. Additional ground plane on the host PCB will substantially enhance the performance of the module. For best performance, place the module on the host PCB following the recommendations in **Section 1.2 "Mounting Details"**.

The Printed Circuit Board (PCB) antenna was designed and simulated using Ansoft Designer[®] and HFSS™ 3D full-wave solver software by Ansoft Corporation (www.ansoft.com). The design goal was to create a compact, low-cost antenna with the best radiation pattern. Figure 2-9 shows the simulation drawing and Figure 2-10 and Figure 2-11 show the 2D and 3D radiation patterns, respectively. As shown by the radiation patterns, the performance of the antenna is dependant upon the orientation of the module. Figure 2-12 shows the impedance simulation and Figure 2-13 shows the actual impedance measurement. The discrete matching circuitry matches the impedance of the antenna with the MRF24J40 transceiver IC.

FIGURE 2-8: PCB ANTENNA DIMENSIONS

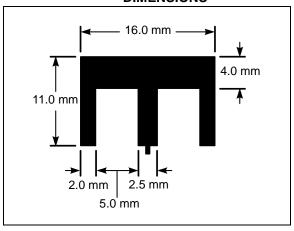
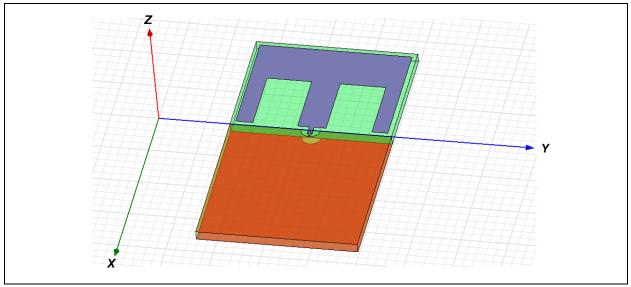
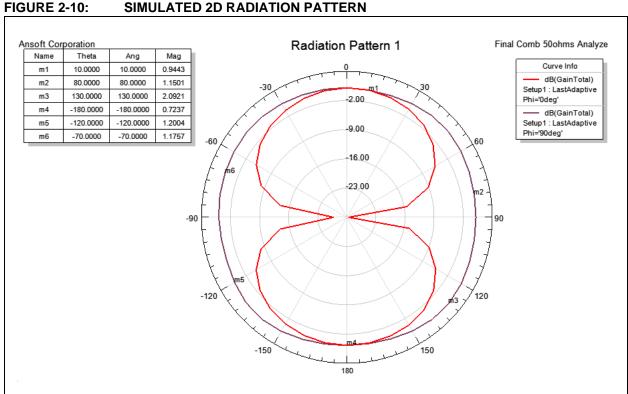


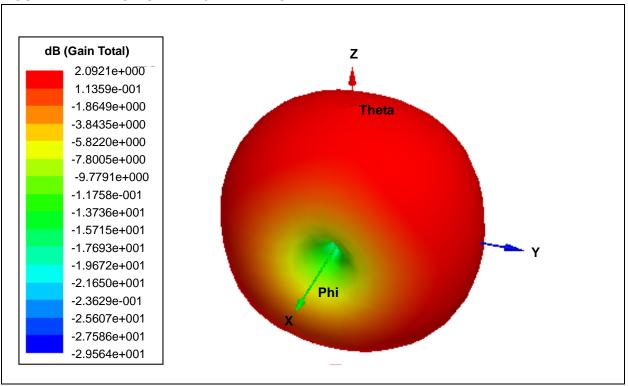
FIGURE 2-9: PCB ANTENNA SIMULATION DRAWING

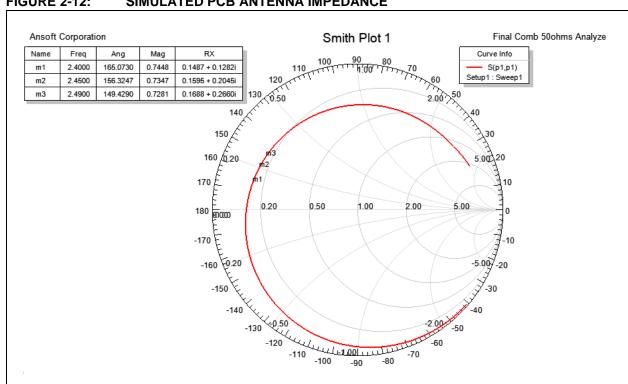






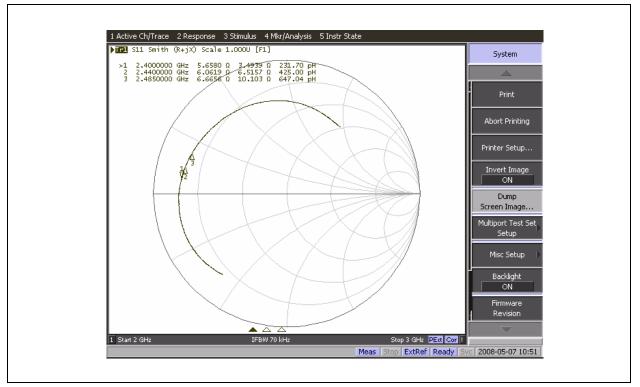






SIMULATED PCB ANTENNA IMPEDANCE **FIGURE 2-12:**





3.0 REGULATORY APPROVAL

The MRF24J40MA module has received regulatory approvals for modular devices in the United States, Canada and European countries. Modular approval allows the end user to place the MRF24J40MA module inside a finished product and not require regulatory testing for an intentional radiator (RF transmitter), provided no changes or modifications are made to the module circuitry. Changes or modifications could void the user's authority to operate the equipment. The end user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

The integrator may still be responsible for testing the end product for any additional compliance requirements required with this module installed (for example: digital device emission, PC peripheral requirements, etc.) in the specific country that the end device will be marketed.

Annex F of the IEEE Std. 802.15.4 document has a good summary of regulatory requirements in various countries concerning IEEE Std. 802.15.4 devices. The standard can be downloaded from the IEEE Standards web page: http://standards.ieee.org/getieee802/802.15.html.

Refer to the specific country radio regulations for details on regulatory compliance.

3.1 United States

The MRF24J40MA has received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Subpart C "Intentional Radiators" 15.247 and modular approval in accordance with FCC Public Notice DA 00-1407 Released: June 26, 2000, Part 15 Unlicensed Modular Transmitter Approval. The MRF24J40MA module can be integrated into a finished product without obtaining subsequent and separate FCC approvals.

The MRF24J40MA module has been labeled with its own FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

Contains Transmitter Module FCC ID: OA3MRF24J40MA

-or-

Contains FCC ID: OA3MRF24J40MA

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

The user's manual should include the following statement:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.1.1 RF EXPOSURE

All transmitters regulated by FCC must comply with RF exposure requirements. OET Bulletin 65 "Evaluating Compliance with FCC Guidelines for Human Exposure to Radio Frequency Electromagnetic Fields" provides assistance in determining whether proposed or existing transmitting facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC). The bulletin offers guidelines and suggestions for evaluating compliance.

If appropriate, compliance with exposure guidelines for mobile and unlicensed devices can be accomplished by the use of warning labels and by providing users with information concerning minimum separation distances from transmitting structures and proper installation of antennas.

The following statement must be included as a CAUTION statement in manuals and OEM products to alert users of FCC RF Exposure compliance:

To satisfy FCC RF Exposure requirements for mobile and base station transmission devices, a separation distance of 20 cm or more should be maintained between the antenna of this device and persons during operation. To ensure compliance, operation at closer than this distance is not recommended.

The antenna(s) used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

If the MRF24J40MA module is used in a portable application (antenna is less than 20 cm from persons during operation), the integrator is responsible for performing Specific Absorption Rate (SAR) testing in accordance with FCC rules 2.1091.

3.1.2 HELPFUL WEB SITES

Federal Communications Commission (FCC) http://www.fcc.gov

3.2 Canada

The MRF24J40MA module has been certified for use in Canada under Industry Canada (IC) Radio Standards Specification (RSS) RSS-210 and RSS-Gen.

From section 7.1.1 RSS-Gen, Issue 2, June 2007, Modular Transmitter Approval:

Host devices which contain separately certified modules do not need to be recertified, provided that they meet the following conditions:

- The host device, as a stand-alone unit without any separately certified modules, complies with all applicable Radio Standards Specifications.
- b) The host device and all the separately certified modules it contains jointly meet the RF exposure compliance requirements of RSS-102, if applicable.
- c) The host device complies with the certification labeling requirements of each of the modules it contains.

Note: Compliance of a module in its final configuration is the responsibility of the applicant. A host device will not be considered certified if the instructions regarding antenna configuration provided in the original description, of one or more separately certified modules it contains, were not followed

From section 5.2, RSS-Gen, Issue 2, June 2007, Equipment Labels:

All Category I radio equipment intended for use in Canada shall permanently display on each transmitter, receiver, or inseparable combination thereof, the applicant's name (i.e., manufacturer's name, trade name or brand name), model number and certification number. This information shall be affixed in such a manner as to not be removable except by destruction or defacement. The size of the lettering shall be legible without the aid of magnification, but is not required to be larger than 8-point font size. If the device is too small to meet this condition, the information can be included in the user manual upon agreement with Industry Canada.

Label:

Contains IC: 7693A-24J40MA

From section 7.1.6, RSS-Gen, Issue 2, June 2007, Digital Circuits:

If the device contains digital circuitry that is not directly associated with the radio transmitter, the device shall also have to comply with ICES-003, Class A or B as appropriate, except for ICES-003 labeling requirements. The test data obtained (for the ICES-003 tests) shall be kept by the manufacturer or importer whose name appears on the equipment label, and made available to Industry Canada on request, for as long as the model is being marketed in Canada.

3.2.1 HELPFUL WEB SITES:

Industry Canada http://www.ic.gc.ca/

3.3 Europe

The MRF24J40MA module has been certified for use in European countries. The following testing has been completed:

Test standard ETSI EN 300 328 V1.7.1 (2006-10)

- Maximum Transmit Power
- · Maximum EIRP Spectral Density
- · Frequency Range
- · Radiated Emissions

Test standards ETSI EN 301 489-1:2008 and ETSI EN 301 489-17:2008

- · Radiated Emissions
- · Electro-Static Discharge
- · Radiated RF Susceptibility

A helpful document that can be used as a starting point in understanding the use of short range devices (SRD) in Europe is the European Radio Communications Committee (ERC) Recommendation 70-03 E, downloadable from the European Radio Communications Office (ERO) http://www.ero.dk.

The end user is responsible for ensuring compliance with harmonized frequencies and labeling requirements for each country the end device is marketed and sold.

3.3.1 HELPFUL WEB SITES:

Radio And Telecommunications Terminal Equipment (R&TTE)

http://ec.europa.eu/enterprise/rtte/index_en.htm

European Conference of Postal and Telecommunications Administrations (CEPT) http://www.cept.org/

European Telecommunications Standards Institute (ETSI) http://www.etsi.org/

European Radio Communications Office (ERO) http://www.ero.dk/

NOTES:

© 2008 Microchip Technology Inc.

4.0 ELECTRICAL CHARACTERISTICS

TABLE 1: RECOMMENDED OPERATING CONDITIONS

Parameters	Min	Тур	Max	Units
Ambient Operating Temperature	-40	_	+85	°C
Supply Voltage for RF, Analog and Digital Circuits	2.4	_	3.6	V
Supply Voltage for Digital I/O	2.4	3.3	3.6	V
Input High Voltage (VIH)	0.5 x VDD	_	VDD + 0.3	V
Input Low Voltage (VIL)	-0.3	_	0.2 x VDD	V

TABLE 2: CURRENT CONSUMPTION

 $(TA = 25^{\circ}C, VDD = 3.3V)$

Chip Mode	Condition	Min	Тур	Max	Units
Sleep		_	2		μΑ
TX	At maximum output power	_	23	_	mA
RX		_	19	_	mA

TABLE 3: RECEIVER AC CHARACTERISTICS

Typical values are at TA = 25°C, VDD = 3.3V, LO frequency = 2.445 GHz

Parameters	Condition	Min	Тур	Max	Units
RF Input Frequency	Compatible to IEEE Std. 802.15.4™, 2003	2.405	_	2.480	GHz
RF Sensitivity		_	-94	_	dBm
Maximum RF Input		+5	_	_	dBm
LO Leakage	Measured at balun matching network input at frequency 2.405-2.48 GHz	_	-60	_	dBm
Input Return Loss	Externally matched to 50 ohm source by a balun matching network	-8	-12	_	dB
Noise Figure (including matching)		_	8	_	dB
Adjacent Channel Rejection	@ +/-5 MHz	30	_	_	dB
Alternate Channel Rejection	@ +/-10 MHz	40	_	_	dB
RSSI Range		_	50	_	dB
RSSI Error		-5	_	5	dB

TABLE 4: TRANSMITTER AC CHARACTERISTICS

Typical values are at TA = 25°C, VDD = 3.3V, LO Frequency = 2.445 GHz

Parameters	Condition	Min	Тур	Max	Units
RF Carrier Frequency		2.405	_	2.480	GHz
Maximum RF Output Power		_	0	+3	dBm
RF Output Power Control Range		_	40	_	dB
TX Gain Control Resolution	Programmed by register	_	1.25	_	dB
Carrier Suppression		_	-30	_	dBc
TX Spectrum Mask for O-QPSK Signal	Offset frequency > 3.5 MHz, at 0 dBm output power	-33	_	_	dBm

APPENDIX A: REVISION HISTORY

Revision A (June 2008)

Original data sheet for the MRF24J40MA device.

NOTES:

DS70329A-page 24

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com, click on Customer Change Notification and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- · Distributor or Representative
- · Local Sales Office
- Field Application Engineer (FAE)
- Technical Support
- · Development Systems Information Line

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://support.microchip.com

READER RESPONSE

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (480) 792-4150.

Please list the following information, and use this outline to provide us with your comments about this document.

lo:	Technical Publications Manager	Total Pages Sent
RE:	1,1	
Fror	m: Name	
	Company	
	Telephone: ()	FAX: ()
Ann	lication (optional):	·
	uld you like a reply?YN	
		iterature Number: DS70329A
		iterature number: D570329A
Que	estions:	
1.	What are the best features of this docu	ment?
	_	
2.	How does this document meet your ha	rdware and software development needs?
•	Decree find the conseniention of this dec	was and a second of allow O. Mars A. volo O.
3.	Do you find the organization of this doc	cument easy to follow? If not, why?
1	What additions to the document do you	ı think would enhance the structure and subject?
т.	what additions to the document do you	Tillink would emiliance the structure and subject:
5.	What deletions from the document cou	ld be made without affecting the overall usefulness?
		S
6.	Is there any incorrect or misleading info	ormation (what and where)?
7.	How would you improve this document	?

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	M	X	Ŧ	<u>-х</u>	Examples:
Device	Module	Module Type	Tape and Reel	Temperature Range	 a) MRF24J40MA-I = Industrial temp. b) MRF24J40MAT-I = Industrial temp., ta reel.
evice	MRF24J40N VDD rang	//A; le 2.4V to 3.6V			
emperature Range	I = -	40°C to +85°	C (Industrial)		



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277

Technical Support:

http://support.microchip.com

Web Address: www.microchip.com

Atlanta

Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca. IL

Tel: 630-285-0071 Fax: 630-285-0075

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Kokomo

Kokomo, IN Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara

Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto

Mississauga, Ontario, Canada Tel: 905-673-0699

Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office

Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon

Hong Kong Tel: 852-2401-1200

Fax: 852-2401-3431

Australia - Sydney

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Tel: 86-10-8528-2100 Fax: 86-10-8528-2104

China - Chengdu

Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Hong Kong SAR

Tel: 852-2401-1200 Fax: 852-2401-3431

China - Nanjing

Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao

Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai

Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang

Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen

Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

China - Wuhan

Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xiamen

Tel: 86-592-2388138 Fax: 86-592-2388130

China - Xian Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

China - Zhuhai Tel: 86-756-3210040

Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore

Tel: 91-80-4182-8400 Fax: 91-80-4182-8422

India - New Delhi

Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune

Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

Japan - Yokohama

Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea - Daegu

Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul

Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur

Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang

Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila

Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore

Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu

Tel: 886-3-572-9526 Fax: 886-3-572-6459

Taiwan - Kaohsiung

Tel: 886-7-536-4818 Fax: 886-7-536-4803

Taiwan - Taipei

Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351

Fax: 66-2-694-1350

EUROPE

Austria - Wels

Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen

Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Munich

Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen

Tel: 31-416-690399 Fax: 31-416-690340

Spain - Madrid

Tel: 34-91-708-08-90 Fax: 34-91-708-08-91 **UK - Wokingham**

Tel: 44-118-921-5869 Fax: 44-118-921-5820